DATE: 05/20/2004

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ELECTRONICS CORPORATION

SMD LED:

KL-170CGX

NO. 61L20010

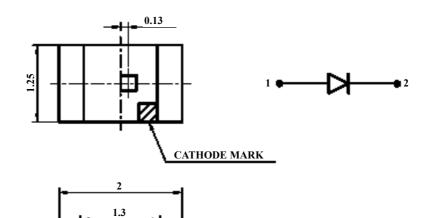
REV.

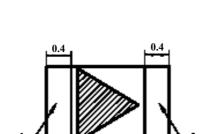
SHEET 1 OF 9

1

UNIT:MM

TOLERANCE: ±0.15





Part No.	Emitting Color	Material	Lens Type	Iv (IF=20mA)		Viewing
				MIN (mcd)	TYP (mcd)	Angle 2 θ 1/2
KL-170CGX	Super brightness green	InGaN	Water Clear	135	165	120°

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SMD LED:

KL-170CGX

NO. 61L20010 R

SHEET 2 OF 9

REV.

Absolute maximum ratings (TA=25°C)		T2G Green (InGaN)		
Reverse voltage	VR	5	V	
Forward current	${f I}_{f F}$	30	mA	
Forward current(Peak)	IFP	100	mA	
1/10 Duty Cycle,0.1ms Pulse Width				
Power dissipation	Pd	105	mW	
LED LAMPS:				
Operating temperature	Тор	-40~+85	$^{\circ}$	
Storage temperature	Tst	-40~+85	$^{\circ}$	
LED DISPLAYS:				
Operating temperature	TA	-40~+85	$^{\circ}$	
Storage temperature	Tstg	-40~+85	$^{\circ}$	

Operating characteristics (TA=25°C)		T2G Green (InGaN)	Unit
Forward voltage(typ.) IF=20mA	VF	3.5	V
Forward voltage(max.) IF=20mA	$\mathbf{V}_{\mathbf{F}}$	4.0	V
Reverse current(max.) V _R =5V	Ir	10	uA
Wavelength at dominant emission(typ.)	λь	525	nm
I _F =20mA Wavelength at peak emission(typ.)	λР	523	nm
I _F =20mA Spectral line half-width	Δλ	36	nm
IF=20mA Capacitance VF=0V,f=1MHz	C	20	pF

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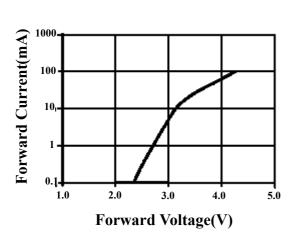
KL-170CGX

NO.61L20010

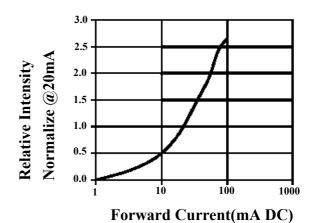
REV.

SHEET 3 OF 9

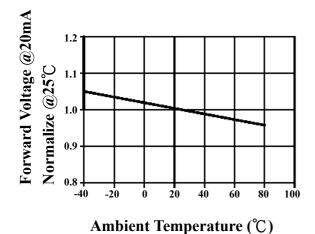
1



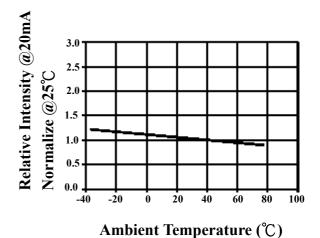
Forward Current Vs. Forward Voltage



Relative Intensity Vs. Forward Current



Forward Voltage Vs.
Ambient Temperature



Relative Intensity Vs. Ambient Temperature

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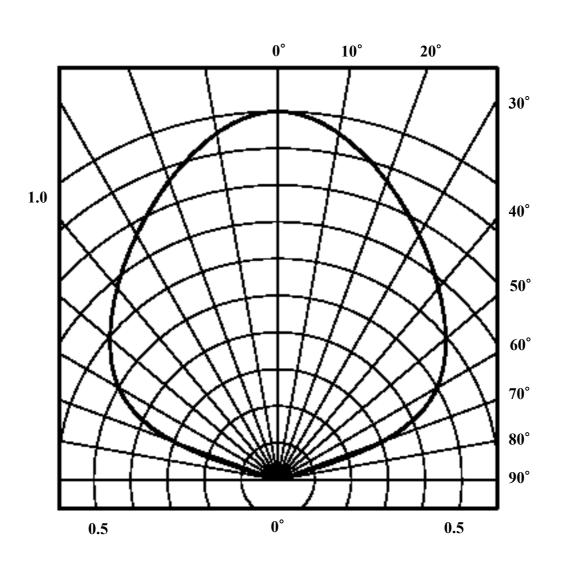
KL-170CGX

SMD LED:

NO. 61L20010 REV.

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View Angle 2 *∂* 1/2=120°

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SMD LED:

KL-170CGX

NO. 61L20010

REV.

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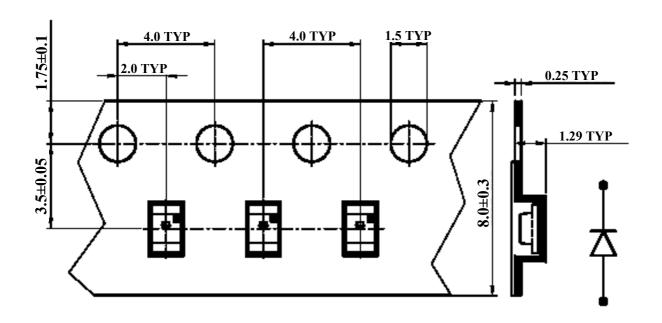
UNIT:MM

TOLERANCE: ±0.25

TYPE

PACKAGE:2000 OR 1000PCS/REEL

REEL"T":14mmTYP



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SMD LED:

KL-170CGX

NO. 61L20010

REV.

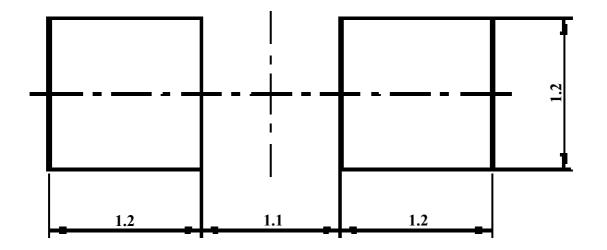
SHEET 6 OF 9

1

UNIT:MM

The following soldering patterns are recommended for reflow-soldering:

For reflow soldering



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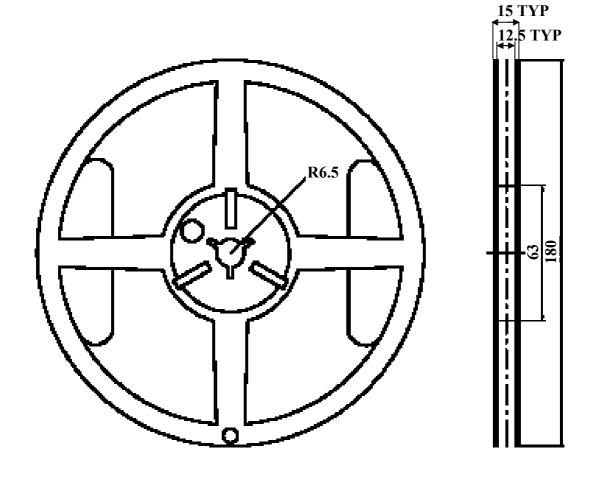
REV.

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UNIT:MM

TOLERANCE: ±0.25



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TEMPERATURE

SMD LED:

KL-170CGX

NO. 61L20010

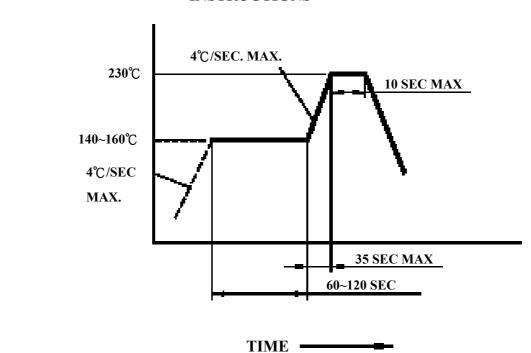
REV.

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SOLDERING

SMT REFLOW SOLDERING INSTRUCTIONS



SOLDERING INSRTUCTIONS							
TYPES	DIP AND WAVE SOLDERING			IRON SOLDERING(WITH 1.5mm IRON TIP)			
	TEMPERATURE OF THE SOLDERING BATH	MAXLMUM SOLDERING TIME	DISTANCE FORM SOLDER JOINT TO CASE	TEMPERATURE OF SOLDERING IRON	MAXLMUM SOLDERING TIME	DISTANCE FROM SOLDER JOINT TO CASE	
LEDS -	≦260 ℃	38	>2mm	≦260 ℃	38	>2mm	
	≦260 ℃	5 S	>4mm	≦260 ℃	5 S	>4mm	
DISPLAYS	≦260 ℃	3S	>2mm	≦260 ℃	3S	>2mm	
	•						

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SMD LED:

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REV.

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SMD HANDLING AND APPLICATION PRECAUTIONS

STORAGE

(1.1)It is recommended to store the devices in accordance with the following conditions:

Humidity: 60%RH Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ ($41^{\circ}\text{F} \sim 86^{\circ}\text{F}$)

(1.2)Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <30%RH.

After the package is opened, the products should be used within 72hrs.

Or they should be kept at $\leq 20\%\text{RH}$ in zip -locked sealed bags.

DRY PACK AND BAKING

SMD LEDs are MOISTURE SENSITIVE devices. Avoid absorbing moisture at any time during transportation and/or storage. It is recommended to bake before soldering when the pack is unsealed after 72 hrs, or any suspicious moisture being found. Bake devices in accordance with the following conditions:

- (a) $60\pm3^{\circ}$ C x (12~24hrs) and <5%RH, taped reel type
- (b) $100\pm3^{\circ}$ C x (45min~1hr), loose packing type, or
- (c) $130\pm3^{\circ}$ C x (15~30min), loose packing type

ELECTRIC STATIC DISCHARGE(ESD) PROTECTION

Materials with GaN, InGaN, AlInGaP are STATIC SENSITIVE devices. They will be packed in anti-static bags. ESD protection must be deliberatively observed from the initial design stage. The static -electric discharge may result in severe malfunction of the devices. In the events of manual working in process, make sure the devices are well protected from ESD at any time. Surge before and during handling products.